

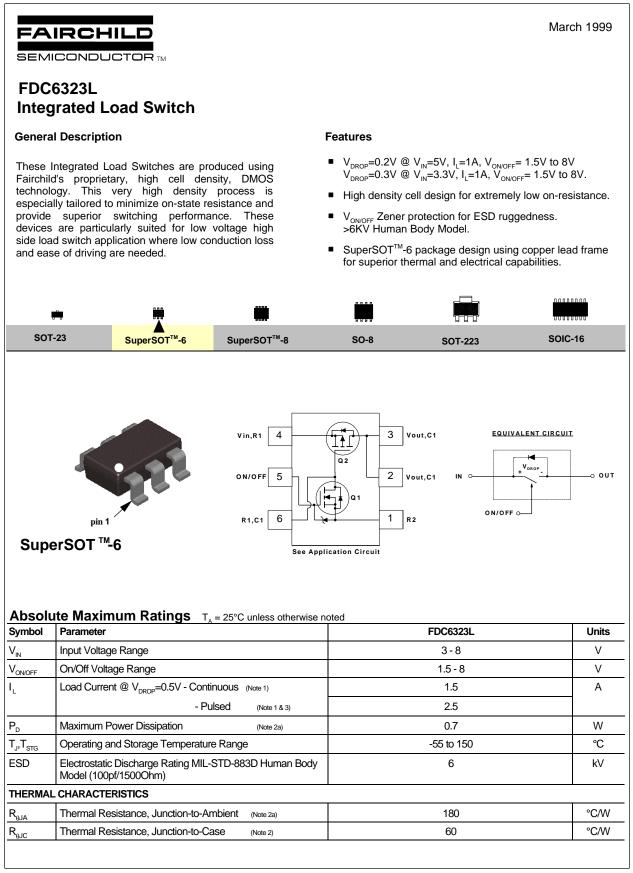
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Electrical Characteristics (T <sub>A</sub> = 25°C unless otherwise noted)								
Symbol	Parameter	Conditions	Min	Тур	Max	Units		
OFF CHA	RACTERISTICS							
I <sub>FL</sub>	Forward Leakage Current	$V_{IN} = 8 V, V_{ONOFF} = 0 V$			1	μA		
I <sub>RL</sub>	Reverse Leakage Current	$V_{IN} = -8 V, V_{ONOFF} = 0 V$			-1	μA		
ON CHAR	ACTERISTICS (Note 3)							
V <sub>IN</sub>	Input Voltage		3		8	V		
V <sub>ON/OFF</sub>	On/Off Voltage		1.5		8	V		
VDROP	Conduction Voltage Drop @ 1A	$V_{IN} = 5 \text{ V}, V_{ONOFF} = 3.3 \text{ V}$		0.145	0.2	V		
		$V_{IN} = 3.3 \text{ V}, V_{ONOFF} = 3.3 \text{ V}$		0.178	0.3			
I <sub>L</sub>	Load Current	$V_{DROP} = 0.2 \text{ V}, V_{IN} = 5 \text{ V}, V_{ONOFF} = 3.3 \text{ V}$	1			Α		
		$V_{DROP} = 0.3 \text{ V}, V_{IN} = 3.3 \text{ V}, V_{ONOFF} = 3.3 \text{ V}$	1			1		

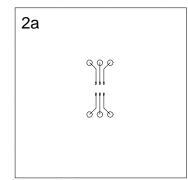
Notes:

1.  $V_{IN}$ =8V,  $V_{ON/OFF}$ =8V,  $V_{DROP}$ =0.5V,  $T_A$ =25°C

2. R<sub>pk</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>pk</sub> is guaranteed by design while  $\mathsf{R}_{_{\theta CA}}$  is determined by the user's board design.

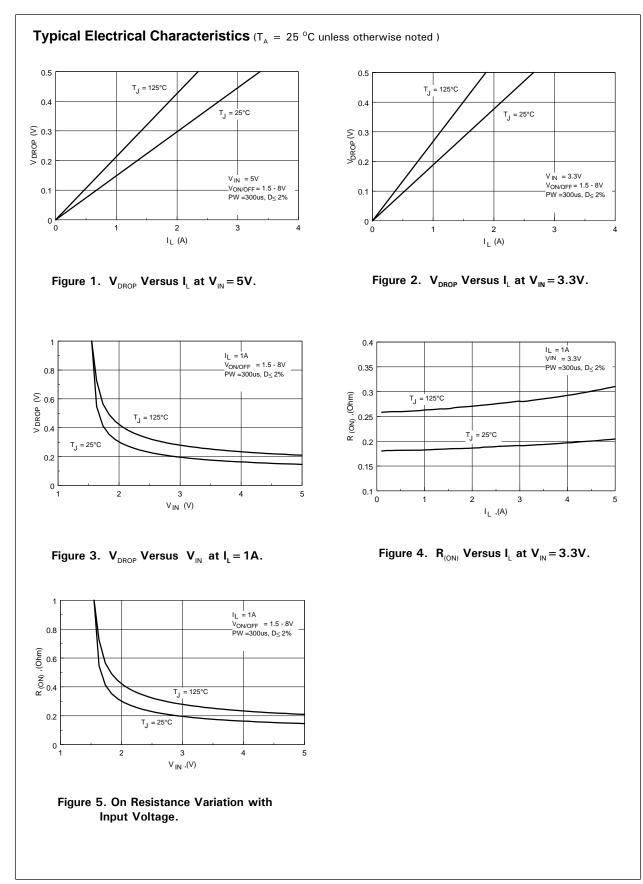
 $P_{D}(t) = \frac{T_{J} - T_{A}}{R_{0,J,A}(t)} = \frac{T_{J} - T_{A}}{R_{0,J,C} R_{0,CA}(t)} = I_{D}^{2}(t) \times R_{DS(ON) \otimes T_{J}}$ Typical R<sub>ain</sub> for single device operation using the board layouts shown below on FR-4 PCB in a still air environment:

a. 180°C/W when mounted on a 2oz minimum copper pad.

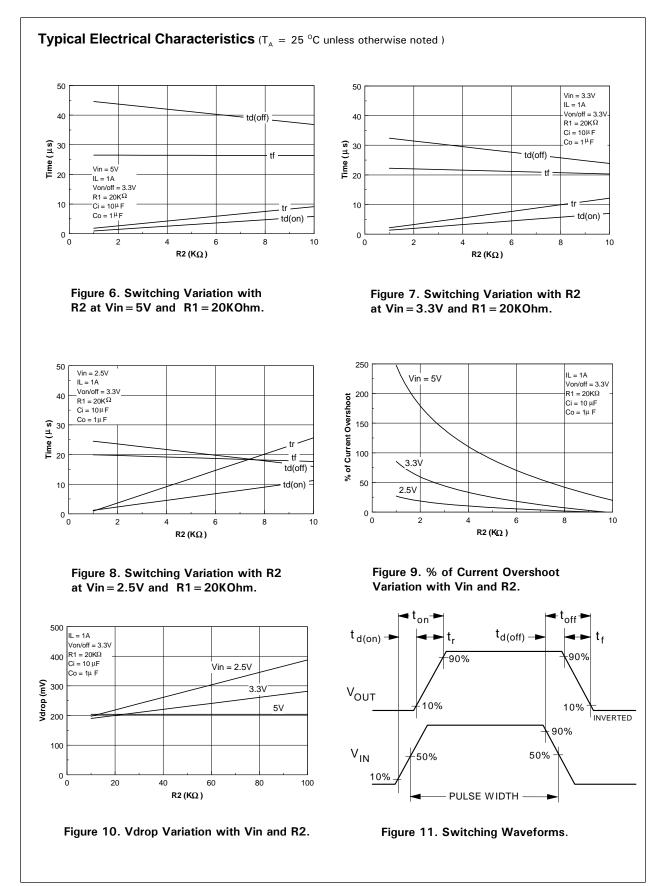


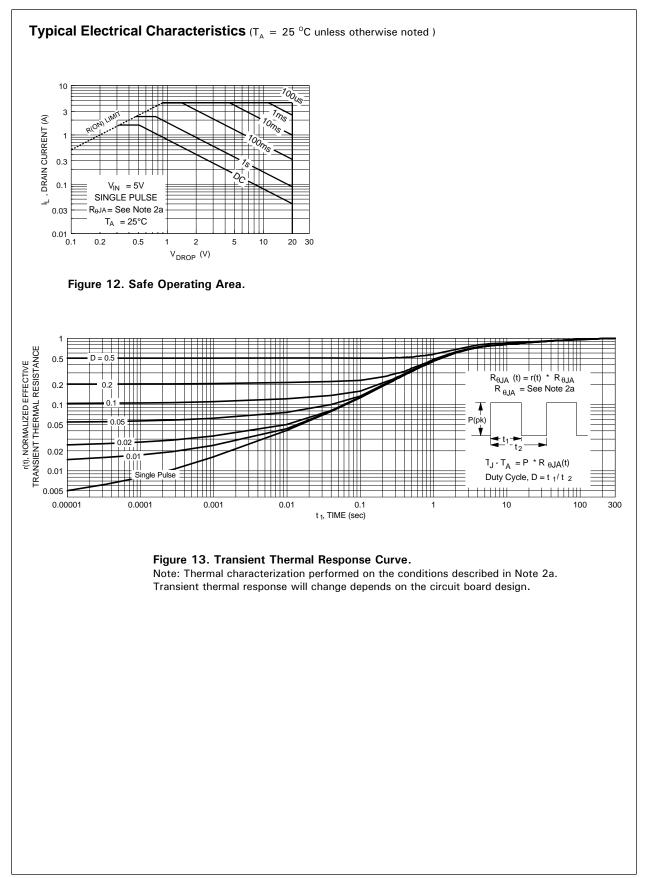
Scale 1 : 1 on letter size paper

3. Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2.0%



FDC6323L Rev.F

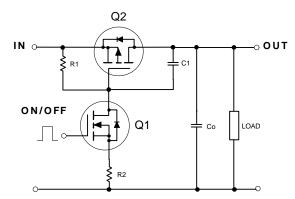




FDC6323L Rev.F

# FDC6323L Load Switch Application





# **General Description**

This device is particularly suited for compact computer peripheral switching applications where 8V input and 1A output current capability are needed. This load switch integrates a small N-Channel Power MOSFET (Q1) which drives a large P-Channel Power MOSFET (Q2) in one tiny SuperSOT<sup>TM</sup>-6 package.

A load switch is usually configured for high side switching so that the load can be isolated from the active power source. A P-Channel Power MOSFET, because it does not require its drive voltage above the input voltage, is usually more cost effective than using an N-Channel device in this particular application. A large P-Channel Power MOSFET minimizes voltage drop. By using a small N-Channel device the driving stage is simplified.

### **Component Values**

R1	Typical	10k - 1MΩ	
R2	Typical	0 - $100k\Omega$	(optional)
C1	Typical	1000pF	(optional)

## Design Notes

- R1 is needed to turn off Q2.
- R2 can be used to soft start the switch in case the output capacitance Co is small.
- R2 should be at least 10 times smaller than R1 to guarantee Q1 turns on.
- By using R1 and R2 a certain amount of current is lost from the input. This bias current loss is given by the equation

 $I_{BIAS_{LOSS}} = \frac{Vin}{R1 + R2}$  when the switch is ON.  $I_{BIAS_{LOSS}}$  can be minimized by selecting a large

value for R1.

• R2 and C<sub>RSS</sub> of Q2 make ramp for slow turn on. If excessive overshoot current occurs due to fast turn on, additional capacitance C1 can be added externally to slow down the turn on.

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